



BAS116QA

Low-leakage diode

3 May 2016

Product data sheet

1. General description

Single low-leakage current switching diode encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} = 0.8 \mu s$
- Low leakage current: $I_R = 3 \text{ pA}$
- Repetitive peak reverse voltage $V_{RRM} \leq 85 \text{ V}$
- Low capacitance $C_d = 2 \text{ pF}$
- Ultra small SMD plastic package
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

3. Applications

- Low-leakage current applications
- General-purpose switching

4. Quick reference data

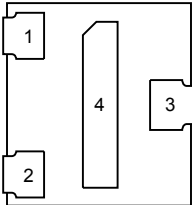
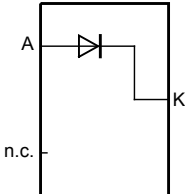
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{RRM}	repetitive peak reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$		-	-	85	V
I_F	forward current	$T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	-	-	300	mA
V_R	reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$		-	-	75	V
V_F	forward voltage	$I_F = 150 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$		-	-	1.25	V
I_R	reverse current	$V_R = 75 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$		-	0.003	5	nA
t_{rr}	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; I_{R(meas)} = 1 \text{ mA}; R_L = 100 \text{ } \Omega; T_{amb} = 25 \text{ }^\circ\text{C}$		-	0.8	3	μs

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 <p>Transparent top view DFN1010D-3 (SOT1215)</p>	 <p>aaa-021941</p>
2	n.c.	not connected		
3	K	cathode		
4	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS116QA	DFN1010D-3	DFN1010D-3: plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body 1.1 x 1.0 x 0.37 mm	SOT1215

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS116QA	Z 110

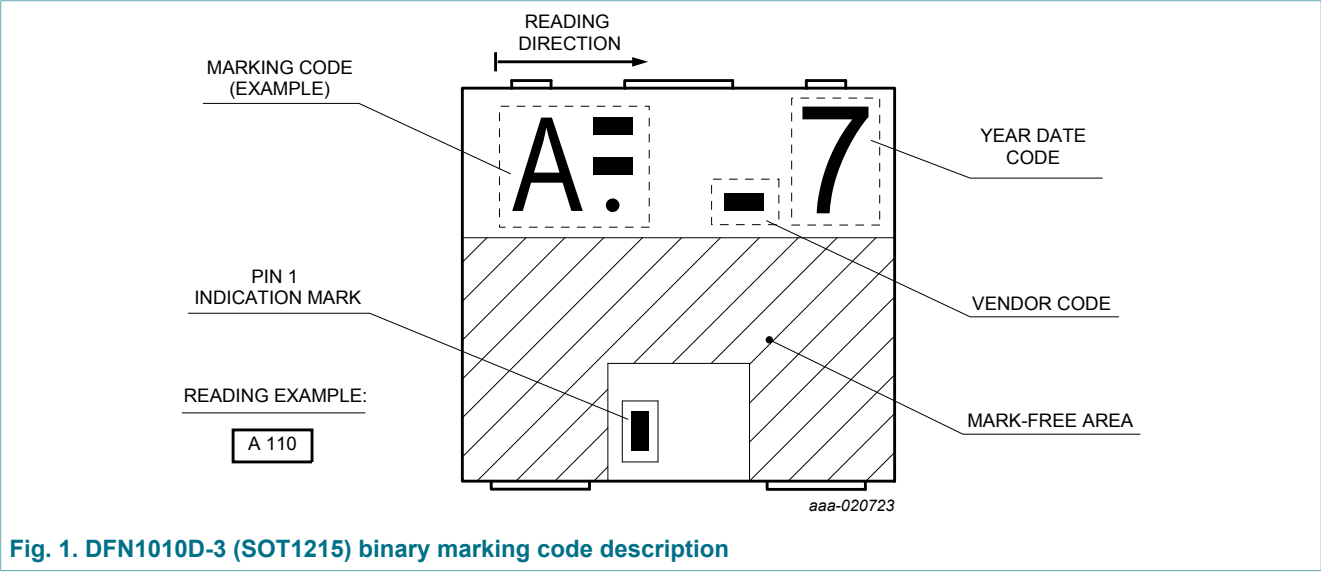


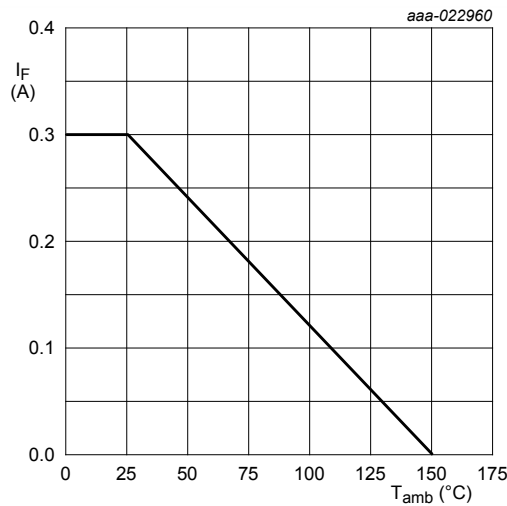
Fig. 1. DFN1010D-3 (SOT1215) binary marking code description

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	75	V
V_{RRM}	repetitive peak reverse voltage			-	85	V
I_F	forward current	$T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	300	mA
I_{FRM}	repetitive peak forward current	$t_p \leq 0.5\text{ ms}$; $\delta \leq 0.25$; $T_j = 25\text{ }^{\circ}\text{C}$		-	700	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 100\text{ }\mu\text{s}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; square wave		-	4	A
		$t_p = 1\text{ ms}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; square wave		-	1.5	A
		$t_p = 1\text{ s}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; square wave		-	0.5	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	[1]	-	305	mW
			[2]	-	470	mW
T_j	junction temperature			-	150	$^{\circ}\text{C}$
T_{amb}	ambient temperature			-55	150	$^{\circ}\text{C}$
T_{stg}	storage temperature			-65	150	$^{\circ}\text{C}$

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².



FR4 PCB, standard footprint

Fig. 2. Forward current as a function of ambient temperature; derating curve

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	410	K/W
			[2]	-	-	265	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	55	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
[3] Soldering point of cathode tab.

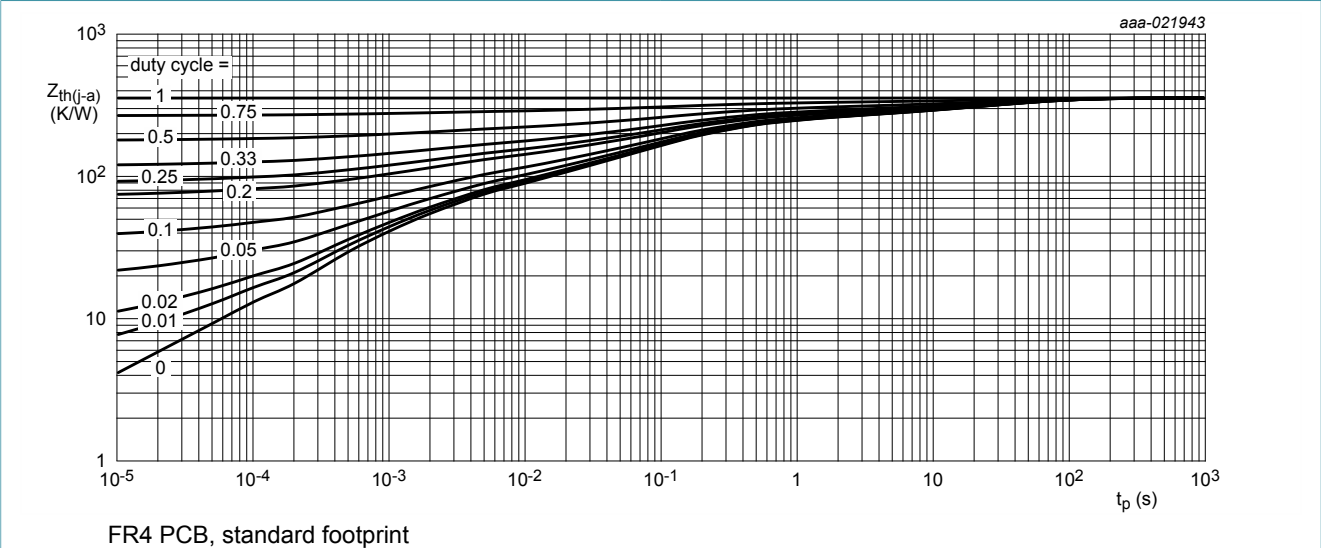


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

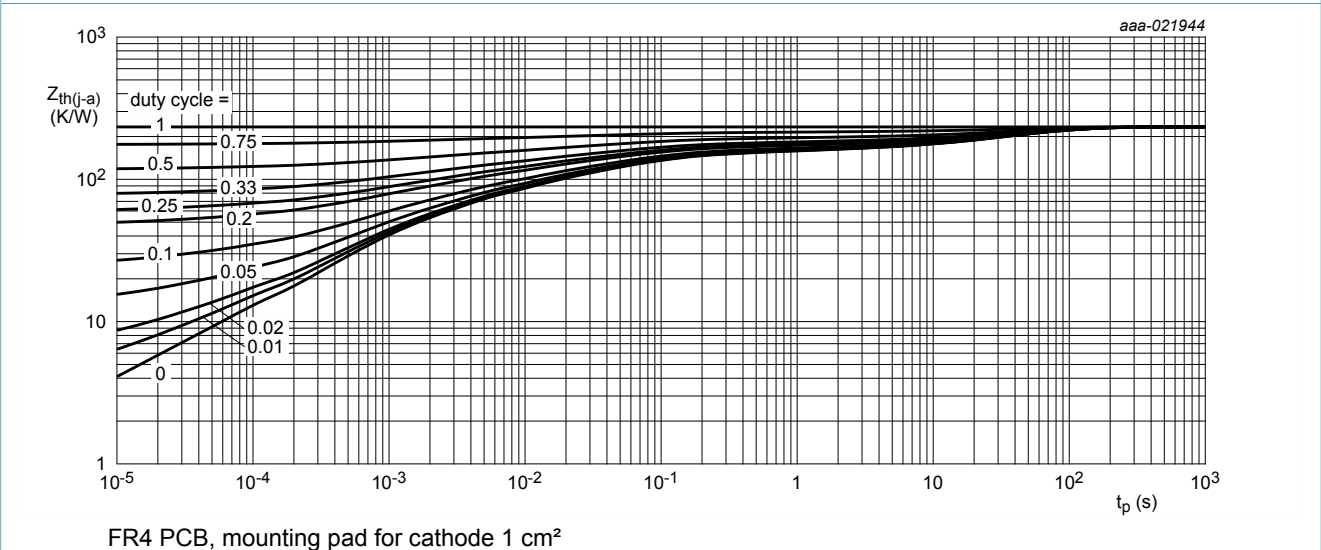
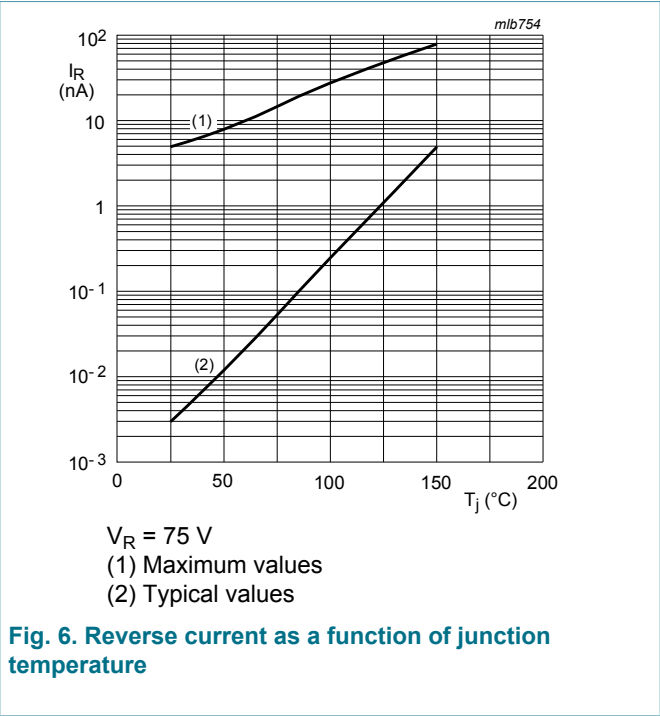
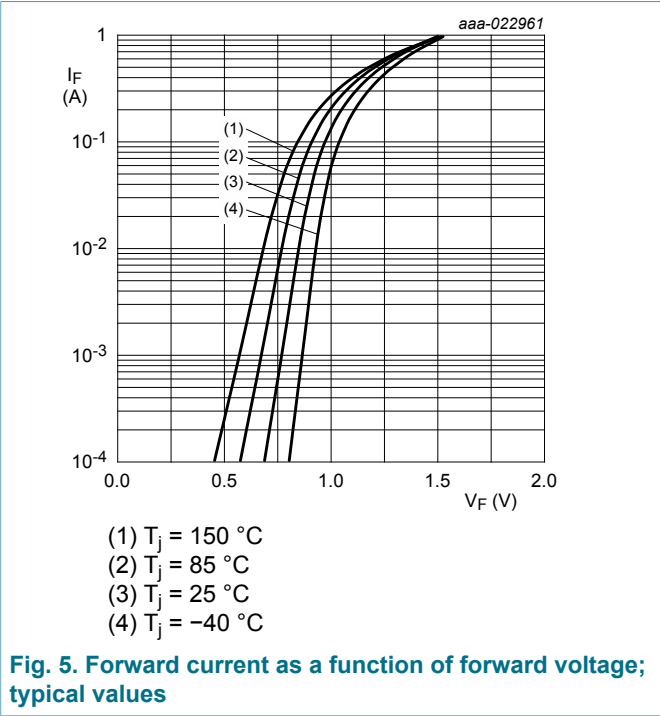


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 1\text{ mA}; T_j = 25\text{ }^{\circ}\text{C}$	-	-	0.9	V
		$I_F = 10\text{ mA}; T_j = 25\text{ }^{\circ}\text{C}$	-	-	1	V
		$I_F = 50\text{ mA}; T_j = 25\text{ }^{\circ}\text{C}$	-	-	1.1	V
		$I_F = 150\text{ mA}; T_j = 25\text{ }^{\circ}\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 75\text{ V}; T_j = 25\text{ }^{\circ}\text{C}$	-	0.003	5	nA
		$V_R = 75\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$	-	3	80	nA
C_d	diode capacitance	$V_R = 0\text{ V}; f = 1\text{ MHz}; T_j = 25\text{ }^{\circ}\text{C}$	-	2	-	pF
t_{rr}	reverse recovery time	$I_F = 10\text{ mA}; I_R = 10\text{ mA}; I_{R(meas)} = 1\text{ mA}; R_L = 100\text{ }\Omega; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	0.8	3	μs



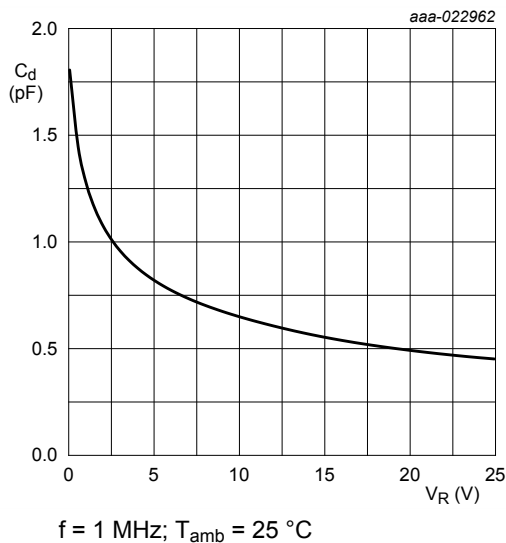


Fig. 7. Diode capacitance as a function of reverse voltage; typical values

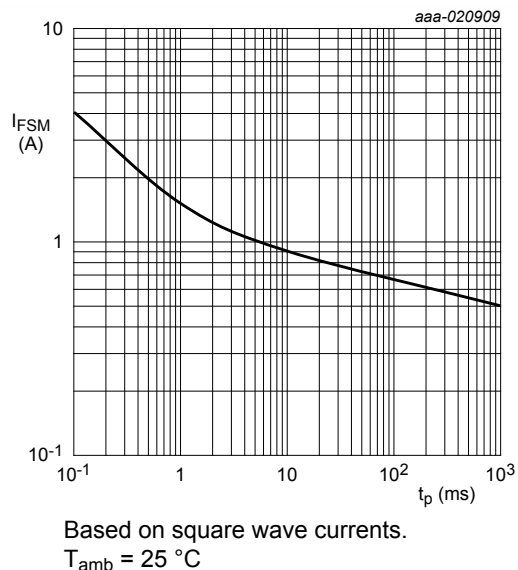


Fig. 8. Non-repetitive forward current as a function of pulse duration; maximum values

11. Test information

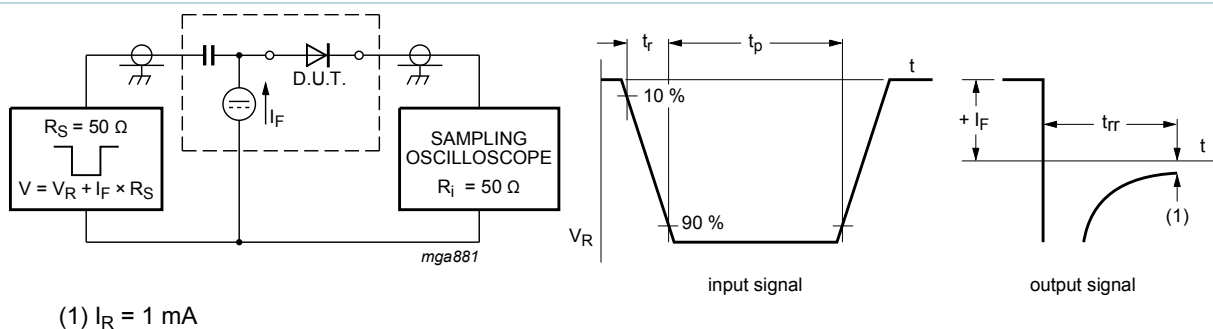


Fig. 9. Reverse recovery time test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline (minimized)

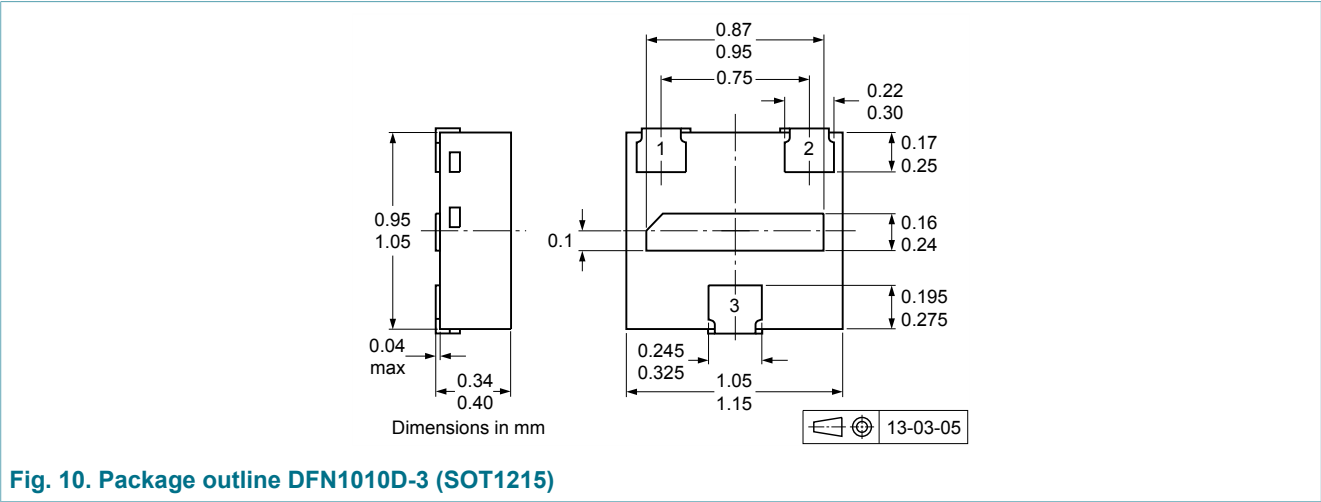
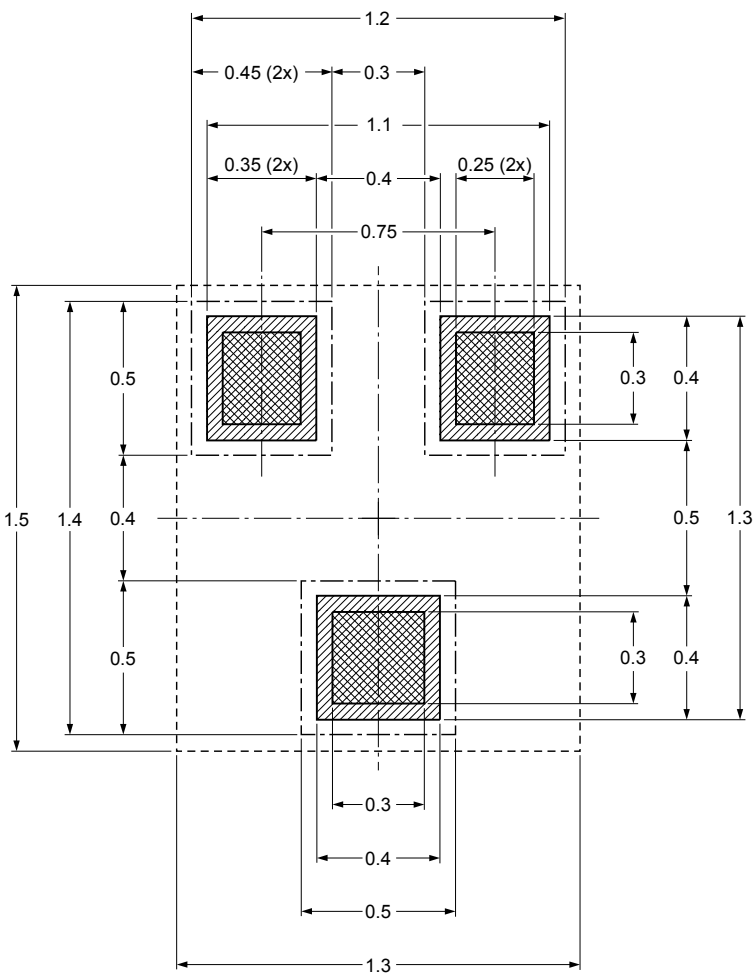






Fig. 10. Package outline DFN1010D-3 (SOT1215)

13. Soldering

Footprint information for reflow soldering of DFN1010D-3 package

SOT1215



-  solder land
-  solder land plus solder paste
-  occupied area
-  solder resist

Dimensions in mm

Issue date ~~12-11-23~~
13-03-06

sot1215_fr

Fig. 11. Reflow soldering footprint for DFN1010D-3 (SOT1215)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS116QA v.1	20160503	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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